

Ultra-low clamping and capacitance (ULC) Type

Series/Type: SD0201SL-S1-ULC101 Ordering code: B74121U1036M060

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#### Features

- Bidirectional ESD protection of one high speed I/O line
- ESD protection to IEC 61000-4-2
- Very low clamping voltage
- Low capacitance
- Low leakage current
- Small chip scale package 0201 with a height of 0.15 mm

#### **Applications**

- High-speed interfaces in smartphones, laptops, tablets, wearables and network communication devices and other portable devices with tight space requirements
- USB
- HDMI
- Thunderbolt
- Firewire
- DVI
- DisplayPort
- S-ATA
- SWP / NFC
- Other high-speed interfaces

#### Schematics

A1 X		
又	Pin	Description
6	A1	I/O Pin
B1	B1	GND

Due to the symmetrical configuration no marking information is needed.

A1 and B1 can be interchanged.





B74121U1036M060 SD0201SL-S1-ULC101



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# **Maximum ratings**

Rating	Symbol	Value	Unit
DC working voltage I/O to GND	V <sub>RWM,max</sub>	±3.6	V
ESD robustness contact discharge (acc. to IEC 61000-4-2 standard)	V <sub>ESD,max</sub>	±15	κV
ESD robustness air discharge (acc. to IEC 61000-4-2 standard)	V <sub>ESD,max</sub>	±15	kV
Ambient temperature	TA	-40 +125	°C

# Characteristics (T<sub>A</sub> = 25 °C)

Parameter	Symbol	Conditions	Minimum	Typical	Maximum	Unit
Breakdown voltage	Vbr	I <sub>BR</sub> = 1 mA, I/O to GND	5.3	6.3	7.3	V
Leakage current	l <sub>leak</sub>	V <sub>RWM</sub> = 3.6 V		20	100	nA
Capacitance	С	$f = 1 MHz, V_{DC,bias} = 0 V$		0.65	0.95	pF
	С	f = 1 MHz, V <sub>DC,bias</sub> = 3.6 V		0.55		pF
Trigger voltage	Vtr	TLP 100ns		7.7		V
Holding voltage	Vh	TLP 100ns		1.8		V
Holding current	Ih	TLP 100ns		180		mA
Clamping voltage	V <sub>clamp</sub>	I <sub>TLP</sub> = 8 A, TLP 100ns		3.9		V
	V <sub>clamp</sub>	I <sub>TLP</sub> = 16 A, TLP 100ns		5.2		V
	V <sub>clamp</sub>	I <sub>TLP</sub> = 25 A, TLP 100ns		7.5		V
Dynamic resistance	R <sub>dyn</sub>	ITLP range: 8 …16 A, TLP		0.16		Ω

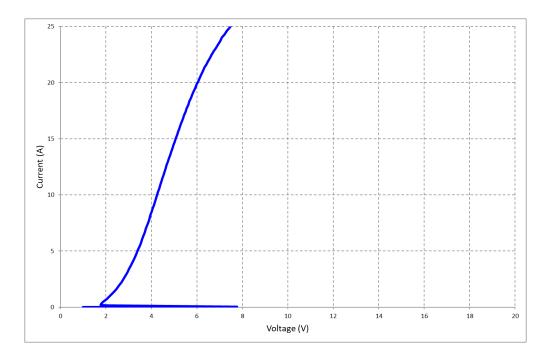
Note: Any operating voltage lower than  $V_{\text{RWM}}$  results in lower leakage current.



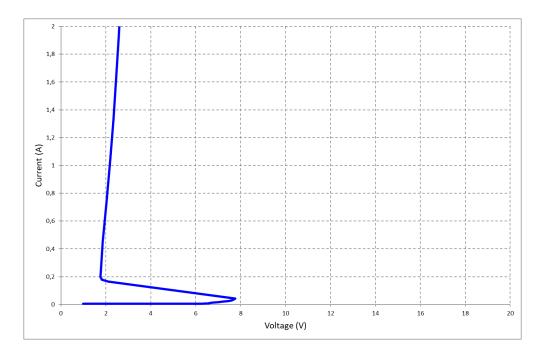
# Ultra-low clamping and capacitance (ULC) Type

B74121U1036M060 SD0201SL-S1-ULC101

# **Typical I-V characteristics**



# Typical I-V characteristics at triggering region



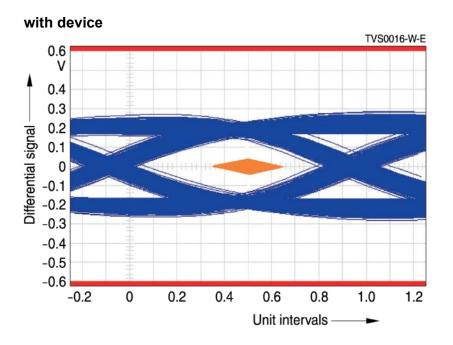
#### PPD ML PD



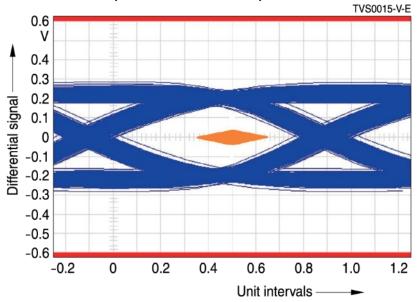
Ultra-low clamping and capacitance (ULC) Type

B74121U1036M060 SD0201SL-S1-ULC101

# USB 3.2 Gen.2 eye diagram (10 Gbps per line, signal frequency 5 GHz)



without device (test board reference)



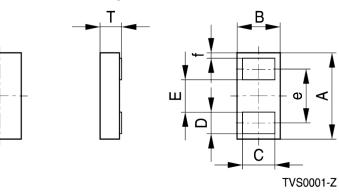
Complete certified USB 3.2 Gen.2 compliance test report available upon request.



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# B74121U1036M060 SD0201SL-S1-ULC101

#### **Dimensional drawing**



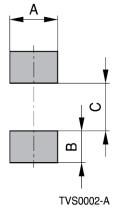
WL-CSP0201 SL				
Symbol	Mean	Tol.		
A	0.58	±0.030		
В	0.28	±0.030		
Т	0.15	±0.010		
С	0.24	±0.020		
D	0.17	±0.020		
E	0.19	(typical)		
е	0.36	(typical)		
f	0.025	(typical)		

Dimensions in mm

∢

Solder pad finish: Ni /Au

# **Recommended reflow soldering footprint**



WL-CSP0201 SL		
Footprint dimensions		
A	0.28	
В	0.19	
С	0.17	

Dimensions in mm

PPD ML PD



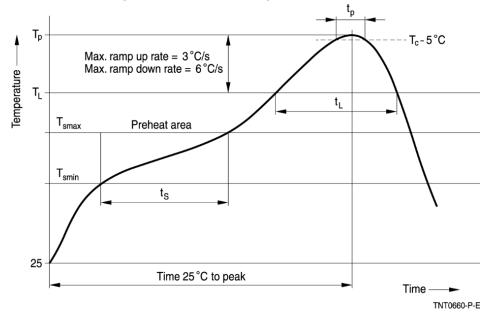
# Ultra-low clamping and capacitance (ULC) Type

B74121U1036M060 SD0201SL-S1-ULC101

#### Recommended soldering profiles acc. JEDEC J-STD-020D

# **Reflow soldering**

Temperature ranges for reflow soldering acc. to IEC 60068-2-58 recommendations.





#### B74121U1036M060

# Ultra-low clamping and capacitance (ULC) Type

B741210103011000

SD020	1SL-S1-l	JLC101

Profile feature	Symbol	Sn-Pb eutectic assembly	Pb-free assembly
Preheat and soak			
– Temperature min.	T <sub>smin</sub>	100 °C	150 °C
– Temperature max.	T <sub>smax</sub>	150 °C	200 °C
– Time	t <sub>smin</sub> to t <sub>smax</sub>	60 120 s	60 120 s
Average ramp-up rate	T <sub>smax</sub> to T <sub>p</sub>	3 °C/s max.	3 °C/s max.
Liquidous temperature	ΤL	183 °C	217 °C
Time at liquidous	t∟	40 150 s	40 150 s
Classification temperature	Tc	260 °C max.	260 °C max.
Peak package body temperature	T <sub>p</sub> <sup>1)</sup>	215 260 °C	235 260 °C
Time (t <sub>p</sub> ) above (T <sub>c</sub> -5 °C )	tp	10 40 s	10 40 s
Average ramp-down rate	T <sub>p</sub> to T <sub>smax</sub>	6 °C/s max.	6 °C/s max.
Time 25 °C to peak temperature		maximum 8 min	maximum 8 min

1) Depending on package thickness

Iron soldering should be avoided, hot air methods are recommended for repair purposes.

#### Soldering guidelines

# Recommended solder

The use of no-clean solder products is recommended. In any case mild, non-activated fluxes should be used. Flux residues after soldering should be minimized.

**Note**: All temperatures refer to topside of the package, measured on the package body surface. Number of reflow cycles: 3



#### Ultra-low clamping and capacitance (ULC) Type

B74121U1036M060 SD0201SL-S1-ULC101

#### Taping and packaging

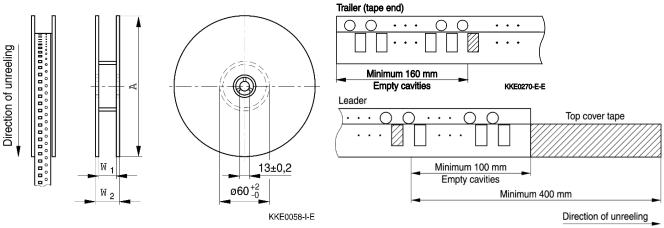
- Tape and reel packing according to IEC 60286-3
- Tape material: Cardboard
- Component pitch in tape: 2 mm

#### **Dimensions and tolerances**

Definition	Symbol	Dimension	Definition
Tape width	W	8.0	±0.3

- Package: 8-mm tape
- Packing material: Plastic

#### **Reel dimensions**



KKE0289-Q-E

Definition	Symbol	Dimension	Tolerance
		mm	mm
Reel diameter	A	180	+0/-3
Reel width (inside)	W <sub>1</sub>	8.4	+1.5/-0
Reel width (outside)	W2	14.4	max.

#### Packing unit: 20000 pcs / reel



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B74121U1036M060 SD0201SL-S1-ULC101

# Cautions and warnings

#### General

Some parts of this publication contain statements about the suitability of our transient voltage suppressor (TVS) for certain areas of application, including recommendations about incorporation/design-in of these products into customer applications. The statements are based on our knowledge of typical requirements often made of our TVS devices in the particular areas. We nevertheless expressly point out that such statements cannot be regarded as binding statements about the suitability of our TVS components for a particular customer application. As a rule, TDK Electronics is either unfamiliar with individual customer applications or less familiar with them than the customers themselves. For these reasons, it is always incumbent on the customer to check and decide whether the TVS devices with the properties described in the product specification are suitable for use in a particular customer application.

- Do not use TDK Electronics TVS components for purposes not identified in our specifications, application notes and data books.
- Ensure the suitability of a TVS in particular by testing it for reliability during design-in. Always evaluate a TVS component under worst-case conditions.
- Pay special attention to the reliability of TVS devices intended for use in safety-critical applications (e.g. medical equipment, automotive, spacecraft, nuclear power plant).

#### Design notes

- Always connect a TVS in parallel with the electronic circuit to be protected.
- Consider maximum rated power dissipation if a TVS has insufficient time to cool down between a number of pulses occurring within a specified isolated time period. Ensure that electrical characteristics do not degrade.
- Consider derating at higher operating temperatures. Choose the highest voltage class compatible with derating at higher temperatures.
- Surge currents beyond specified values will puncture a TVS. In extreme cases a TVS will burst.
- If steep surge current edges are to be expected, make sure your design is as low-inductance as possible.
- In some cases the malfunctioning of TVS components or failure before the end of their service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In applications requiring a very high level of operational safety and especially when the malfunction or failure of a passive electronic component could endanger human life or health (e.g. in accident prevention, life-saving systems, or automotive battery line applications such as clamp 30), ensure by suitable design of the application or other measures (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of such a malfunction or failure.
- Specified values only apply to TVS components that have not been subject to prior electrical, mechanical or thermal damage. The use of TVS devices in line-to-ground applications is therefore not advisable, and it is only allowed together with safety countermeasures like thermal fuses.

# Ultra-low clamping and capacitance (ULC) Type

# Storage

- Only store TVS in their original packaging. Do not open the package before storage.
- Storage conditions in original packaging: temperature −25 to +45°C, relative humidity ≤75% annual average, maximum 95%, dew precipitation is inadmissible.
- Do not store TVS devices where they are exposed to heat or direct sunlight. Otherwise the packaging material may be deformed or TVS may stick together, causing problems during mounting.
- Avoid contamination of the TVS surface during storage, handling and processing.
- Avoid storing TVS devices in harmful environments where they are exposed to corrosive gases for example (SO<sub>x</sub>, CI).
- Use TVS as soon as possible after opening factory seals such as polyvinyl-sealed packages.
  - Solder TVS components after shipment from TDK Electronics within the time specified:
    - TVS with Ni/Au termination, 12 months

# Handling

- Do not drop TVS components and allow them to be chipped.
- Do not touch TVS with your bare hands gloves are recommended.
- Avoid contamination of the TVS surface during handling.
- Washing processes may damage the product due to the possible static or cyclic mechanical loads (e.g. ultrasonic cleaning). They may cause cracks to develop on the product and its parts, which might lead to reduced reliability or lifetime.

## Mounting

- When TVS devices are encapsulated with sealing material or overmolded with plastic material, electrical characteristics might be degraded and the life time reduced.
- Make sure an electrode is not scratched before, during or after the mounting process.
- Make sure contacts and housings used for assembly with TVS components are clean before mounting.
- The surface temperature of an operating TVS can be higher. Ensure that adjacent components are placed at a sufficient distance from a TVS to allow proper cooling.
- Avoid contamination of the TVS surface during processing.

# Soldering

- Complete removal of flux is recommended to avoid surface contamination that can result in an instable and/or high leakage current.
- Use resin-type or non-activated flux.
- Bear in mind that insufficient preheating may cause ceramic cracks.
- Rapid cooling by dipping in solvent is not recommended, otherwise a component may crack.

# **公TDK**

B74121U1036M060

SD0201SL-S1-ULC101



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# B74121U1036M060 SD0201SL-S1-ULC101

#### Operation

- Use TVS only within the specified operating temperature range.
- Use TVS only within specified voltage and current ranges.
- Environmental conditions must not harm a TVS. Only use them in normal atmospheric conditions. Reducing the atmosphere (e.g. hydrogen or nitrogen atmosphere) is prohibited.
- Prevent a TVS from contacting liquids and solvents. Make sure that no water enters a TVS (e.g. through plug terminals).
- Avoid dewing and condensation.
- TDK Electronics TVS components are mainly designed for encased applications. Under all circumstances avoid exposure to:
  - o direct sunlight
  - rain or condensation
  - o steam, saline spray
  - corrosive gases
  - o atmosphere with reduced oxygen content
- TDK Electronics TVS devices are not suitable for switching applications or voltage stabilization where static power dissipation is required.

This listing does not claim to be complete, but merely reflects the experience of TDK Electronics AG.

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- 2. We also point out that in individual cases, a malfunction of electronic components or failure before the end of their usual service life cannot be completely ruled out in the current state of the art, even if they are operated as specified. In customer applications requiring a very high level of operational safety and especially in customer applications in which the malfunction or failure of an electronic component could endanger human life or health (e.g. in accident prevention or life-saving systems), it must therefore be ensured by means of suitable design of the customer application or other action taken by the customer (e.g. installation of protective circuitry or redundancy) that no injury or damage is sustained by third parties in the event of malfunction or failure of an electronic component.
- 3. The warnings, cautions and product-specific notes must be observed.
- 4. In order to satisfy certain technical requirements, some of the products described in this publication may contain substances subject to restrictions in certain jurisdictions (e.g. because they are classed as hazardous). Useful information on this will be found in our Material Data Sheets on the Internet (www.tdk-electronics.tdk.com/material). Should you have any more detailed questions, please contact our sales offices.
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Important notes

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